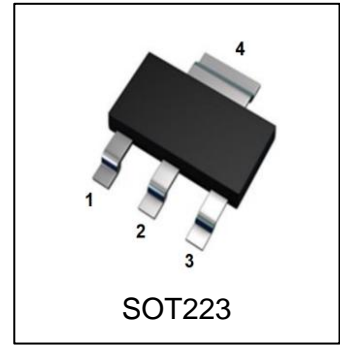


LP035N060TZHG

P-Channel 60V Power MOSFET

1. FEATURES

- Low thermal impedance
- Fast switching speed
- We declare that the material of product compliance with RoHS requirements and Halogen Free.

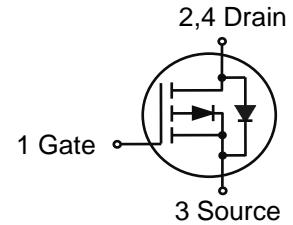


2. APPLICATIONS

- Power Tools
- DC/DC Conversion
- Motor Control

3. DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LP035N060TZHG	GE	1000/Tape&Reel



4. MAXIMUM RATINGS(Ta = 25°C)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	VDS	-60	V
Gate-Source Voltage	VGS	±20	
Continuous Drain Current (Note1)	ID	-3.5	A
Pulsed Drain Current (Note2)	IDM	-14	
Avalanche Current (L = 0.1mH)	IAS	12	A
Avalanche Energy (L = 0.1mH)	EAS	7.2	mJ
Power Dissipation (Note1)	PD	1.9	W
Operating Junction and Storage Temperature Range	TJ , Tstg	-55~+150	°C

5. THERMAL CHARACTERISTICS

Parameter	Symbol	Limits	Unit
Thermal Resistance,Junction-to-Ambient(Note 1)	RθJA	65	°C/W
Thermal Resistance,Junction-to-Case	RθJC	15	°C/W

1."1.5 x 1.5" FR4 board using 1 sq in pad, 2 oz Cu.

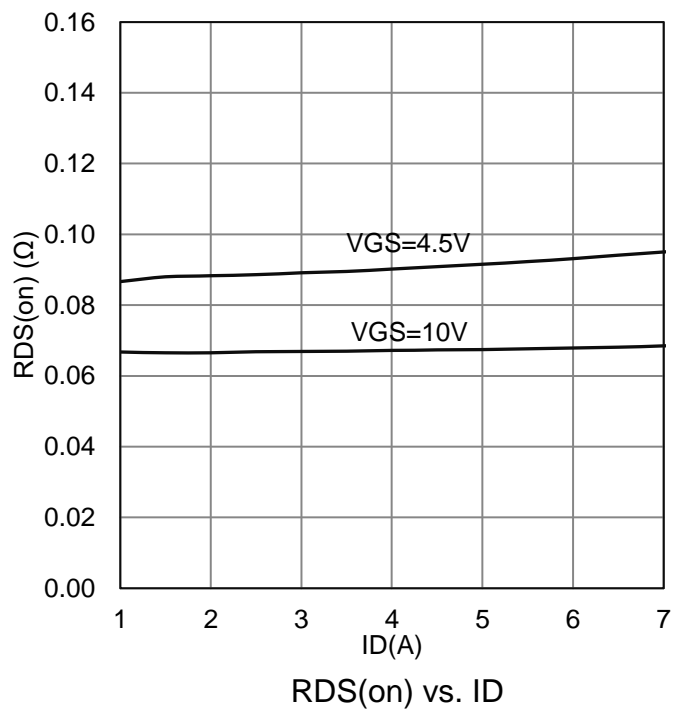
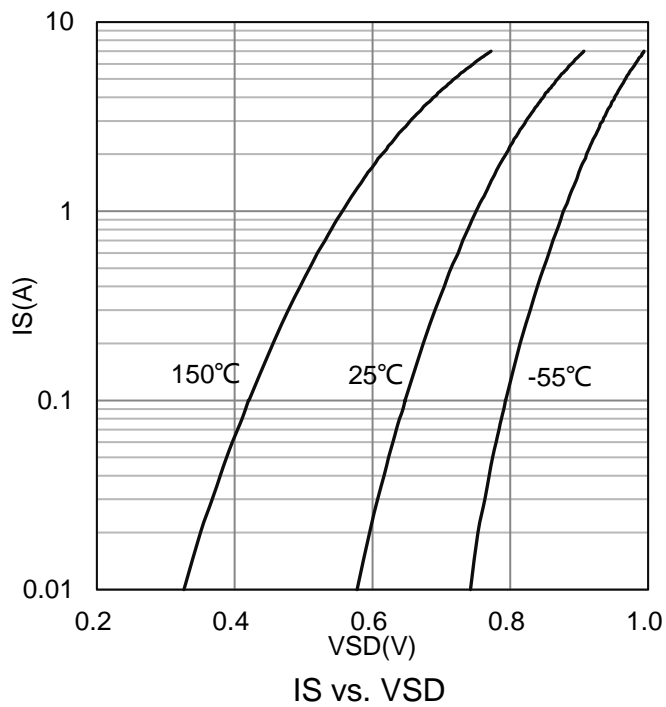
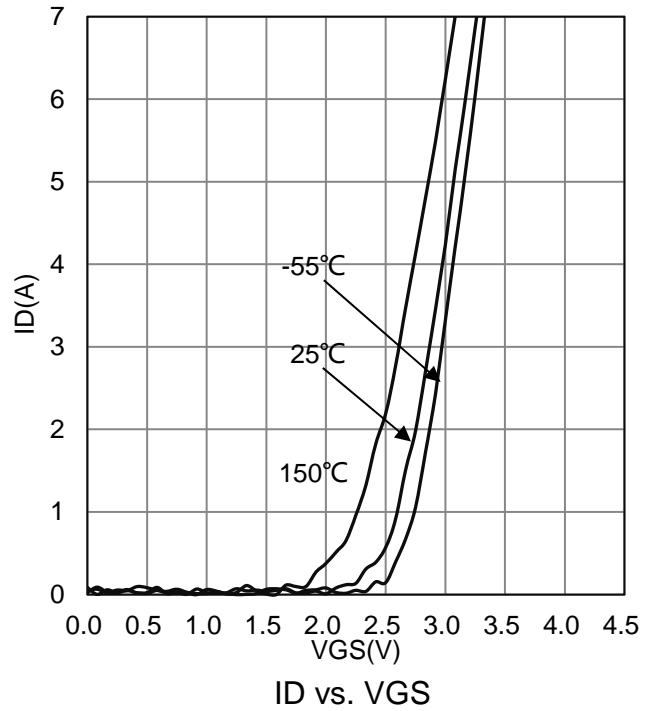
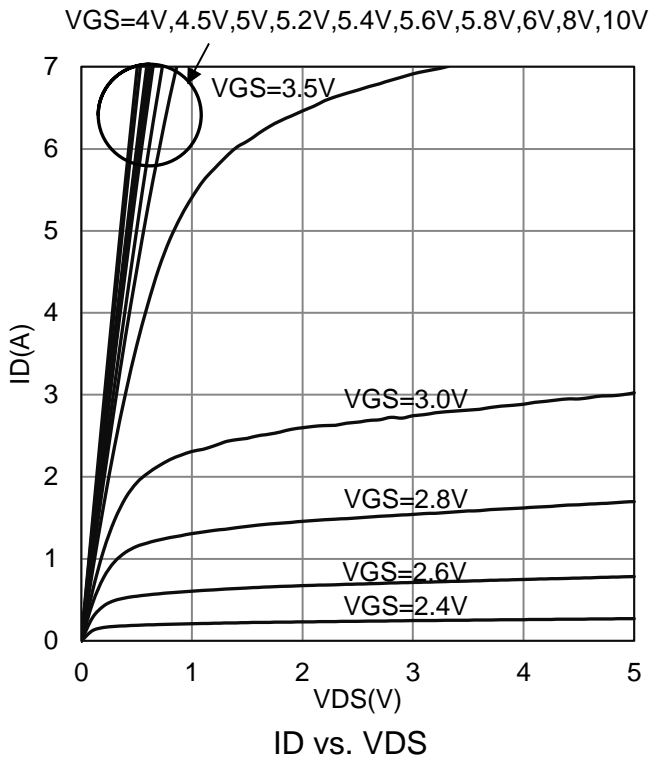
2.Pulse width limited by maximum junction temperature

6. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

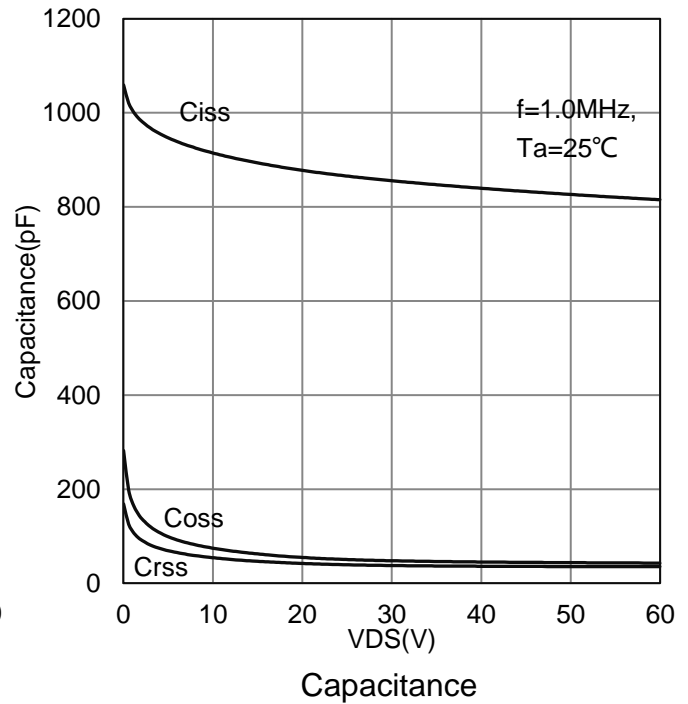
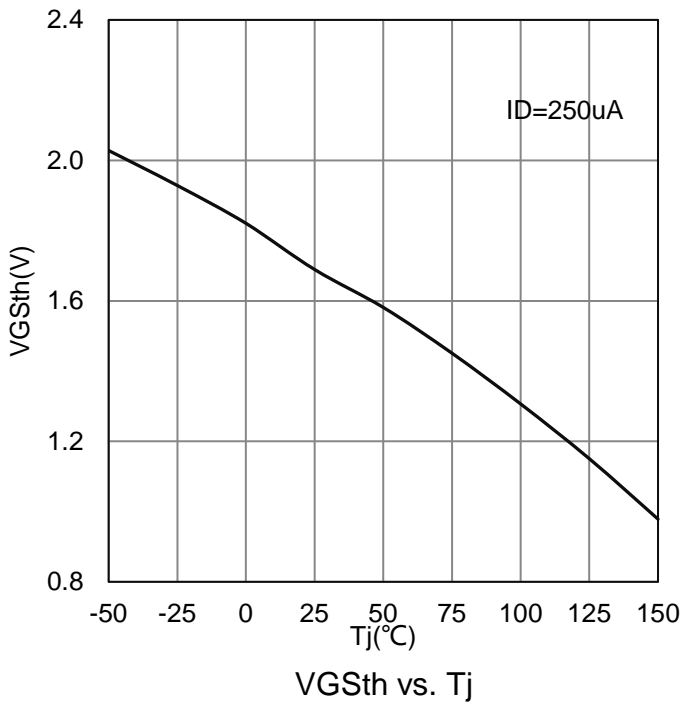
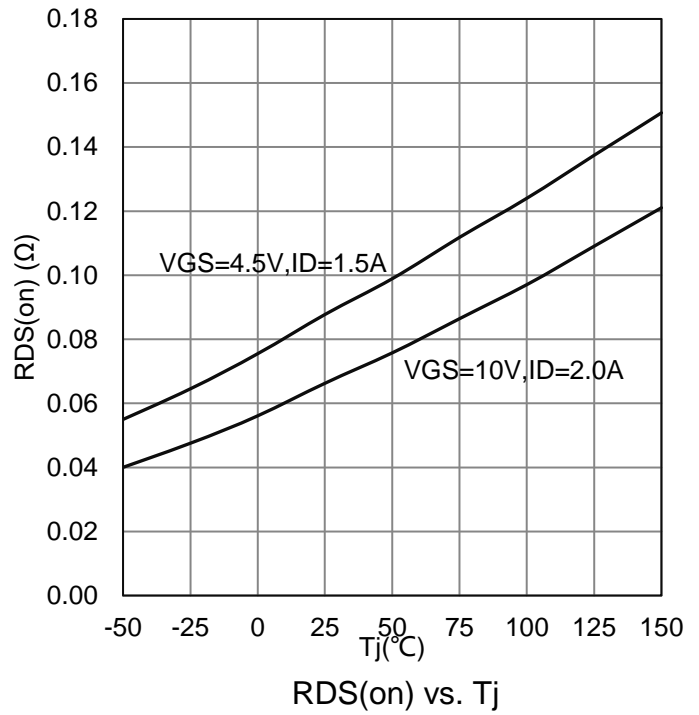
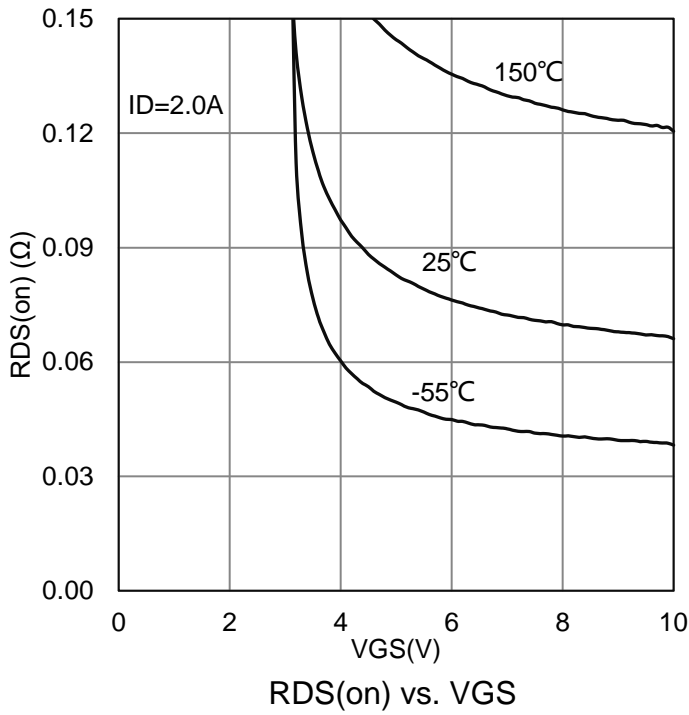
Characteristic	Symbol	Min.	Typ.	Max.	Unit	
Static						
Drain to Source Breakdown Voltage (VGS = 0 V, ID = -250 μA)	BVDSS	-60	-	-	V	
Gate Threshold Voltage (VDS = VGS, ID = -250 μA)	VGS(th)	-1	-	-2.5	V	
Gate-Body leakage current (VDS = 0 V, VGS = ±20 V)	IGSS	-	-	± 100	nA	
Zero Gate Voltage Drain Current (VDS = -48 V, VGS = 0 V)	IDSS	-	-	-1	μA	
Drain-to-Source On-Resistance(Note 3) (VGS = -10 V, ID = -2 A) (VGS = -4.5 V, ID = -1.5 A)	RDS(ON)	-	-	85 115	mΩ	
Diode Forward Voltage (IS = -2 A, VGS = 0 V)	VSD	-	-	-1.2	V	
Dynamic						
Total Gate Charge	(VDS = -30 V, VGS = -4.5 V, ID = -2 A)	Qg	-	7.3	-	nC
Gate to Source Charge		Qgs	-	2.3	-	
Gate to Drain Charge		Qgd	-	3	-	
Turn-on Delay Time	(VDD= -30 V, RL = 15 Ω, ID= -2 A, VGEN= -10 V RGEN = 3 Ω)	td(on)	-	6	-	nS
Rise Time		tr	-	6.5	-	
Turn-Off Delay Time		td(off)	-	45	-	
Fall Time		tf	-	19	-	
Input Capacitance	(VDS = -30 V, VGS = 0 V, f = 1 MHz)	Ciss	-	863	-	pF
Output Capacitance		Coss	-	48	-	
Reverse Transfer Capacitance		Crss	-	39	-	

3. Pulse test; pulse width ≤ 300μs, duty cycle ≤ 2%

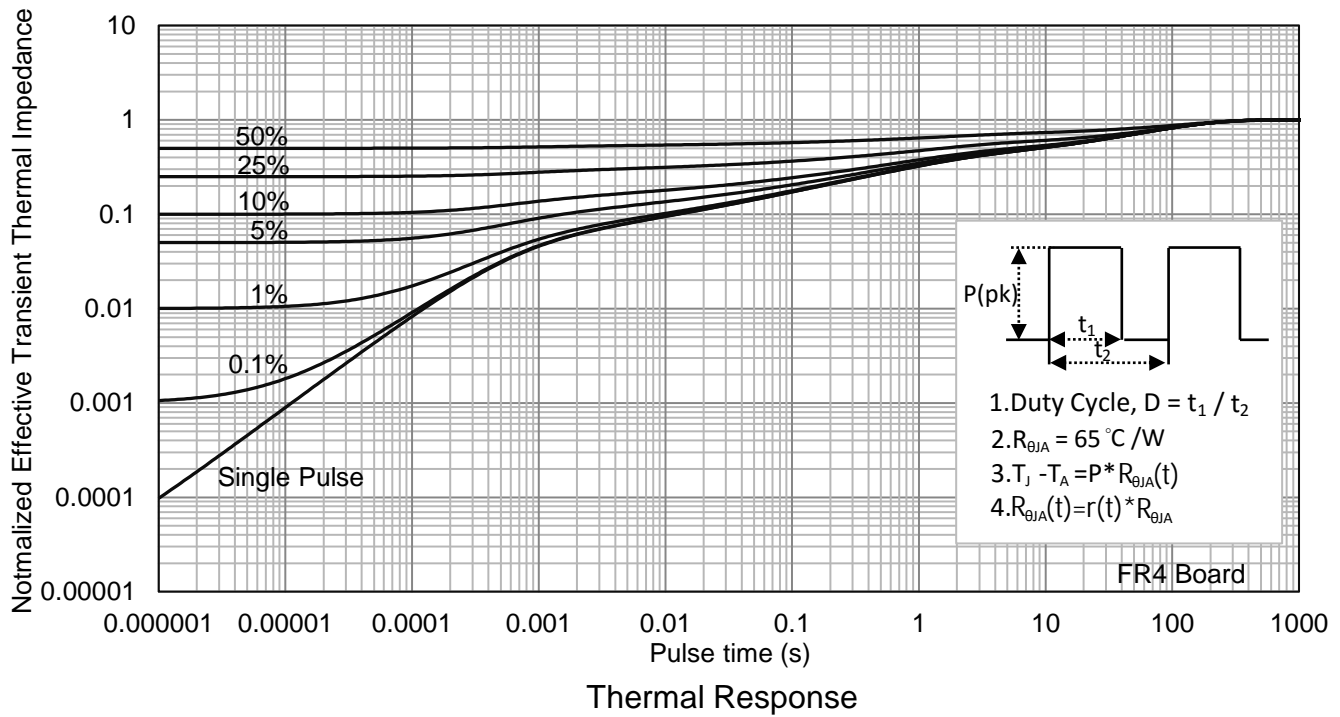
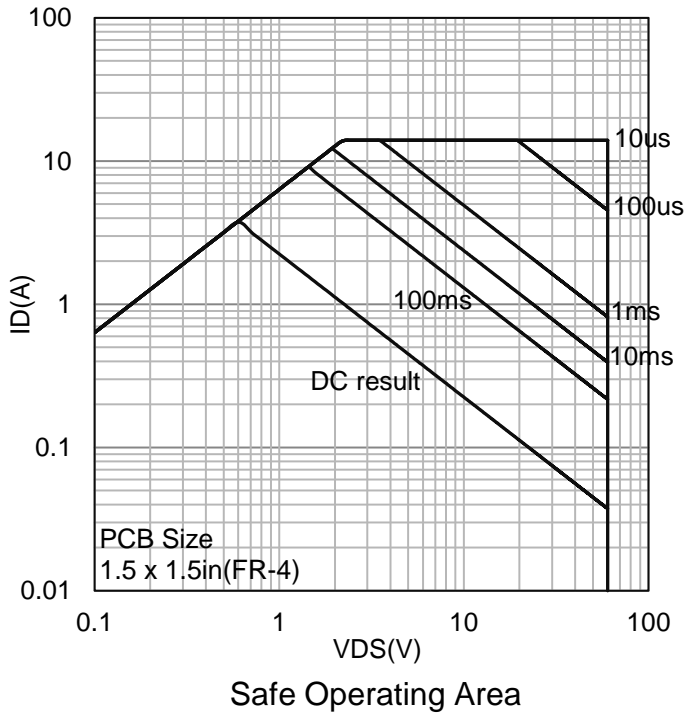
7. ELECTRICAL CHARACTERISTICS CURVES



7. ELECTRICAL CHARACTERISTICS CURVES(Con.)

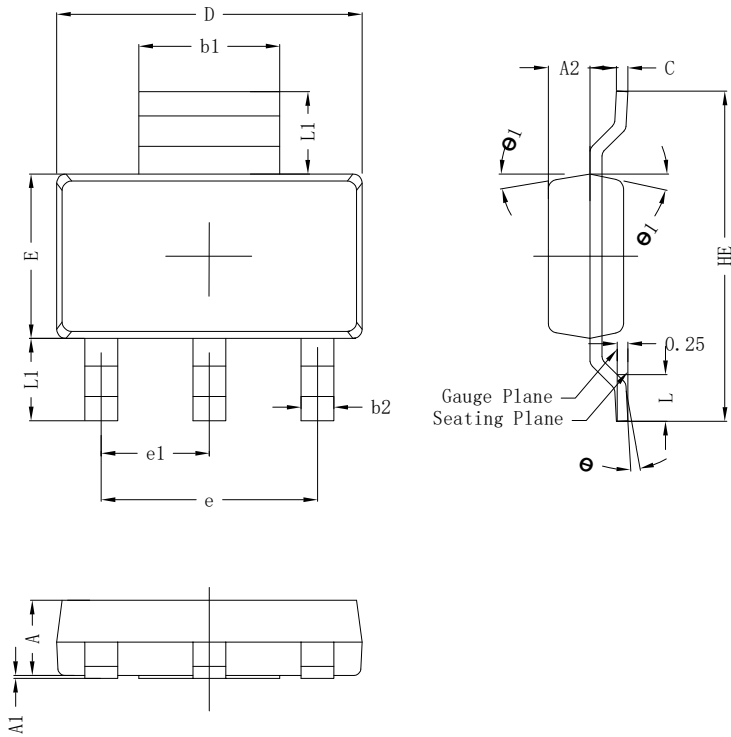


7. ELECTRICAL CHARACTERISTICS CURVES(Con.)



8. OUTLINE AND DIMENSIONS

SOT223

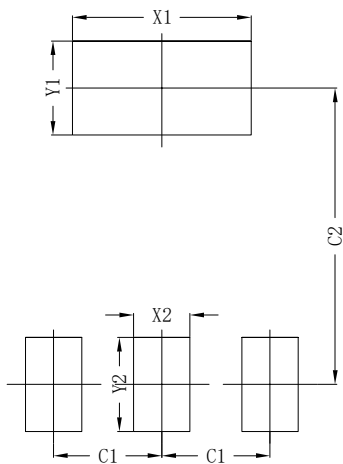


SOT223			
DIM	MIN	NOR	MAX
A	1.50	1.60	1.70
A1	0.00	0.05	0.10
A2	0.80	0.90	1.00
b1	2.90	3.02	3.10
b2	0.60	0.72	0.80
c	0.20	0.27	0.35
D	6.30	6.50	6.70
E	3.30	3.50	3.70
e	4.60BSC		
e1	2.30BSC		
HE	6.80	7.00	7.20
L	0.80	1.00	1.20
L1	1.75(REF)		
θ	0°~8°		
θ 1	8°	10°	12°
All Dimensions in mm			

GENERAL NOTES

1. Top package surface finish Ra0.4±0.2um
2. Bottom package surface finish Ra0.7±0.2um
3. Side package surface finish Ra0.4±0.2um
4. Protrusion or Gate Burrs shall not exceed 0.10mm per side.

9. SOLDERING FOOTPRINT



SOT223	
DIM	(mm)
X1	3.80
Y1	2.00
X2	1.20
Y2	2.00
C1	2.30
C2	6.30

DISCLAIMER

- Curve guarantee in the specification. The curve of test items with electric parameter is used as quality guarantee. The curve of test items without electric parameter is used as reference only.
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